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INFORMATION DISCLOSURE	Application Number	10/073,506
STATEMENT BY APPLICANT	Filing Date	February 11, 2007
(use as many sheets as necessary	Confirmation Number	6190
OIPE	First Named Inventor	Robert J. Falster
c mile m	Group Art Unit	1775 C 20
MAY 1 6 2002	Examiner Name	1700
Sheet of 10	Attorney Docket No.	MEMC 98-1451/2554.1

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IN	IFORMATIC TATEMENT	i N DISC	E LOSURE	Application Number	10/073,506
S	TATEMENT	WHAP	PLICANT	Filing Date	February 11, 2002
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				First Named Inventor	Robert J. Falster
				Group Art Unit	1775
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				Fi	rst Named Inventor	Ro	bert J. Falster
				G	roup Art Unit	17	75
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				First Named Inventor	Robert J. Falster
				Group Art Unit	1775
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Sheet	5	of	10	Attorney Docket No.	MEMC 98-1451/2554.1

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	•			First Named Inventor	Robert J. Falster
				Group Art Unit	1775
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Sheet	6	of	10	Attorney Docket No.	MEMC 98-1451/2554.1

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				First Named Inventor	Robert J. Falster	
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				First Named Inventor	Robert J. Falster et al.	
				Group Art Unit	1765	
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				First Named Inventor	Robert J. Falster et al.		
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				First Named Inventor	Robert J. Falster et al.
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